# LN222RPH

## Round Type

φ2.0 mm

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	er Symbol Rating		Unit	
Power dissipation	$P_{\mathrm{D}}$	P <sub>D</sub> 70		
Forward current	$I_{\mathrm{F}}$	25	mA	
Pulse forward current *	$I_{FP}$	150	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

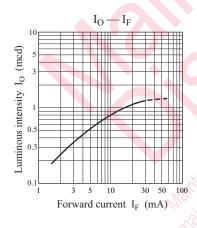
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

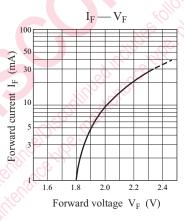
### ■ Lighting Color

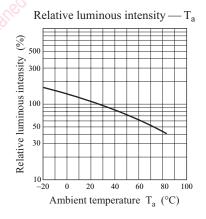
• Red

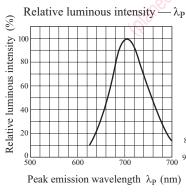
#### ■ Electro-Optical Characteristics $T_a = 25$ °C

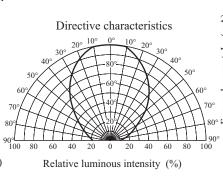
					0	
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>		0.4	1.0	5	mcd
Reverse current	$I_R$	$V_R = 4 V$	,,,,¢t,,,,	"16 <sub>60</sub> ,	5	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 20 \text{ mA}$	100,100	2.2	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$	dillo	700		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	30,	100		nm

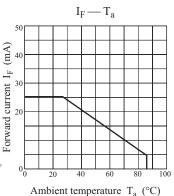










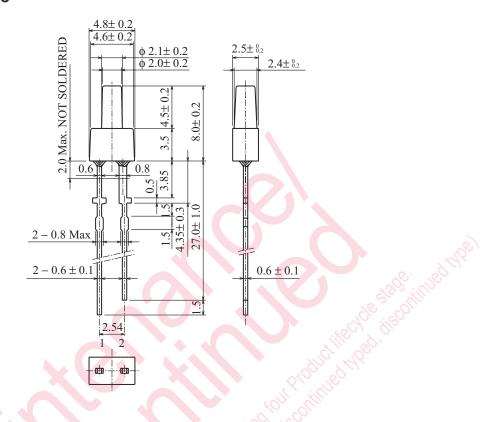


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LN222RPH Panasonic

■ Package (Unit: mm)

## LLXFTN2SF220



- Pin name
  - 1: Anode
  - 2: Cathode

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